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December 17, 2001

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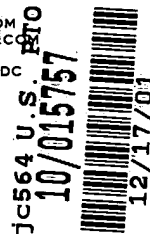
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Atty. Docket No.: P67358US0

CUSTOMER NUMBER: 00136



Honorable Commissioner for Patents  
Washington, D.C. 20231

Sir:

Transmitted herewith for filing is the patent application in the name  
of:

**Hyung-Jun KIM of Ichon-shi, Republic of Korea,**

for **SEMICONDUCTOR DEVICE CAPABLE OF PREVENTING CORROSION OF METAL WIRES  
FROM CMP (CHEMICAL MECHANICAL POLISHING) PROCESS.** The application  
comprises a 13-page specification including 11 claims (2 independent)  
and Abstract, 3 sheets of drawings (Figs. 1-4), and a Declaration and  
Power of Attorney.

Also accompanying this application for filing are:

- (1) Assignment document, cover sheet and **\$40.00** fee for recordation of  
Assignment; and
- (2) A certified copy of **Korean** Application No. **2000-80891**, filed  
**December 22, 2000**, the priority of which is claimed under 35  
U.S.C. §119.

The filing fee has been calculated as shown:

Large Entity	\$ 740.00
Total Claims= <u>11</u> ; in excess of 20 = 0 x (\$18.00) =	
Total Ind. Claims= <u>02</u> ; in excess of 03 = 3 x (\$84.00) = +	
<b>TOTAL FILING FEE:</b>	<b>\$ 740.00</b>

A check in the amount of **\$780.00**, is enclosed to cover the Filing Fee  
and an Assignment Recordation Fee. The Commissioner is hereby  
authorized to charge payment of any fees set forth in Sections 1.16 or  
1.17 during the pendency of this application, or credit any overpayment,  
to deposit Account No. 06-1358. A duplicate copy of this sheet is  
enclosed.

Respectfully submitted,

By: 

Yoon S. Ham

Reg. No. 45,307

Enclosures  
YSH:ecl